

## **AI<sup>2</sup>MD (Artificial Intelligence × Ab Initio Molecular Dynamics) Simulation** of Electrochemical Interfaces: Methods and Applications

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## WHY we need Al<sup>2</sup>MD for EC studies

While *ab initio* simulations have provided valuable **microscopic** insights into EC interfaces, the high computational cost limits their use in tackling complex systems. Machine learning potentials offer a solution, but their application in electrochemistry remains challenging due to the difficulty in treating the dielectric response of electronic conductors and insulators simultaneously...



**ID for EC interfaces** 



Electrolyte

Zhang, Car, et al. JCP 2022 ✓ Reorientational response



Ko, Behler, et al. Nat. Commun. 2021 XNon-local elec. dielectric response



Electrode

XOverestimate polarisability

## **HOW** we achieve Al<sup>2</sup>MD

Therefore, we propose a **hybrid scheme** of MLPs to treat electrochemical interfaces (ec-MLP):

Wannier centroid (WC) method for electrolytes (ionic conductor & electronic insulator)



**Polarisable electrode method** for electrodes (ionic insulator & electronic conductor)

- **Chemical potential**
- Local environment

attractive

interaction

ion - surface

## WHAT we can obtain from Al<sup>2</sup>MD



- **Potential-dependent water ad-/de-sorption**
- **Bell-shaped Helmholtz capacitance** (which requires accurate descriptions of electronic structures!)
- **Chemisorption induces additional dipoles Physisorption lower dipole due to lower HB** number

Ojha, Doblhoff-Dier, Koper, PNAS 2022



Ledezma-Yanez et al., Nat. Ener. 2017

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